PLEASE FILL IN ENGLISH IN CAPITAL LETTERS Last date of receiving application form in the High Commission: 31.08.2018

High Commission of India - Kuala Lumpur Level 28, Menara 1 Mon't Kiara, No. 1, Jalan Kiara, Mon't Kiara, 50480 Kuala Lumpur (Tel: 03 6205 2350 ext 203)

<u>Indian Scholarship & Trust Fund (ISTF) application form for the Academic year 2018-19</u>
(Only for Malaysians of Indian Origin currently studying at Universities / Colleges in Malaysia)

Paste your recent
"Passport Size"
photograph here
(Note: don't attach
the photograph with
a clip; don't staple
the photograph;
instead paste it
firmly at the centre
of this box)

<u>(A)</u>	Par	ticulars of Applicant:						
	1.	Full Name as per IC (in BLOCK letters):						
	2.	Residence Address:						
Hoi	me ⁻	Геlephone: Моb:						
E-mail:								
	3.	Date of Birth: Place of Birth:						
	4.	Nationality:						
	5.	Name & address of Institution of Higher Learning:						
	6.	Currently, what level are you studying? (please circle)						
Fou	unda	ation / A Levels / Matriculation / Certificate / Diploma / Bachelor / Master / PhD / Others						
	7.	Please mention your current course of study: (e.g. Economics)						
	8.	Course Type: (please circle all the options which apply to your course)						
Fulltime / Part-time / Distance Edu / Open Edu / <u>Vocational</u> / <u>Evening College</u> / <u>Twinning</u> / <u>Offshore</u> / <u>O</u>								
	9.	Year of Study (whether 1 st yr, 2 nd yr, etc.):						
	10. Duration of Course: From To							
	11. Date of first joining the Institution:							
	12. Are you in receipt of grants, loan, scholarship or financial aid from other sources? If so, plea							
		furnish details:						
	13.	Are you currently working? YES / NO If Yes, provide details						

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	14. In the past have you received so	Cholarship hom t	ile istr! ((piease circ	de) fes/NO	
	15. If Yes, which Year & how much	Amount?				
<u>(B)</u>	Particulars of parents and members	of family:				
	1. Father's Name:					
	2. Father's Age:					
	3. Father's Occupation:					
	4. Father's monthly Basic Salary:	If r	etired, mo	nthly Pensi	ion/Socso/Welfare:	
	5. Father's Employer's Name i.e. 0	Company Name	& Address	:		
If re	etired, the Name and Address of the	last organization	he worked	d for:		
	mpany / Employer's Telephone Num					
	6. Mother's Name:					
	6. Mother's Age:	Mother'	's Mob:			
	7. Mother's Occupation:	1	If retired, p	lease circle	e: from Government or Private?	
	8. Mother's monthly Basic Salary:	lf	retired, mo	onthly Pens	sion/Socso/Welfare:	
	9. Mother's Employer's Name / Co	ompany Name &	Address: .			
If re	etired, the Name and Address of the	last organization	she worke	ed for:		
	10. Number of brothers in your family			-		
11. Number of sisters in your family: How many of them are Unmarried?						
	12. Details of unmarried brothers their employers i.e. company na		re employe	ed, their mo	onthly incomes & the names of	
#	Name	Designat Job Descr		Income	Employer	
1.						
2.						
3.						
•	13. Any immovable property such a	ıs land, house et	c. owned b	y your pare	ents? If so, please give details:	
#	Property	Value (RM)	Annual /	I / Monthly Income from the property		
1.						
2.						

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14. Details of a person who can testify your character & your family's financial status:

Name:	Designation:						
Address:							
	Phone:						
15. How is this pers	son known to you?						
16. Additional Infor	16. Additional Information (if any) you wish to furnish in connection with your application:						
	<u>Declaration</u>						
l,best of my knowledge a	hereby declare that the information given above is true to the and belief.						
Date:	Signature:						
Note:							

- 1. Age Limit: 25 years; parent's total income (total basic salary) shouldn't exceed RM2,000 per month.
- 2. All fields / columns in the application form should be duly filled in. Incomplete application forms are liable to be rejected.
- 3. Please attach photocopies of SPM / STPM mark sheet (for students just joining colleges) or the latest semester mark sheet for the course of study (for students already studying in colleges). Original documents should NOT be attached.
- 4. Attach a 'letter of proof of studying' from the institution i.e. bonafide certificate / letter.
- 5. Attach photocopy of Salary Slip / Pension Statement / Income Declaration for <u>Both Parents</u>. **Compulsory**.
- 6. Attach a photocopy of the applicant's Malaysian Identity Card (IC).
- 7. The decision of the Selection Committee is Final and NO further correspondence will be entertained in the matter
- 8. Students currently pursuing their *A-Levels, Foundation courses, International Baccalaureate (IB), Australian Matriculation, Canadian Pre-U (CPU)*, etc., are NOT eligible to apply. Only students doing <u>Diploma and Graduate courses</u> are eligible to apply for the ISTF.

Check-list

Past a proper passport size photo at the box provided in the first page of this application. A clear copy of the applicant's IC photocopy.

Photocopy of Bonafide Student Certificate / Letter of Proof of studying to be obtained from the

university / college / institution.

Photocopy of latest mark sheet, (if possible, enclose a guide to convert the grades to percentage).

Salary Slip / Pension Statement / Income Declaration of both parents. *If they are not working*,

enclose a Statutory Declaration signed in front of a Commissioner of Oaths.

In case of single parents, enclose photocopy of the death certificate / divorce papers.

In case of disabled persons (OKU) or persons with health problem, attach proof of disability or a doctor's letter.

Reminder

- i. Don't comb-bind / tape-bind the application. However, do staple the papers in order.
- ii. Don't enclose too many papers and make the application bulky. Enclose only what is necessary.

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iii. Emailed / faxed applications will <u>not</u> be accepted. *Applicants are discouraged from submitting the application by hand*. Please send the application **by post** to:

High Commission of India, Education Wing, Level 28, Menara 1 Mon't Kiara, No. 1, Jalan Kiara, Mon't Kiara, 50480 Kuala Lumpur.

- iv. Applications post-marked after the last date (15.08.2018) would not be accepted.
- v. Only short-listed candidates will be called for the interview.